

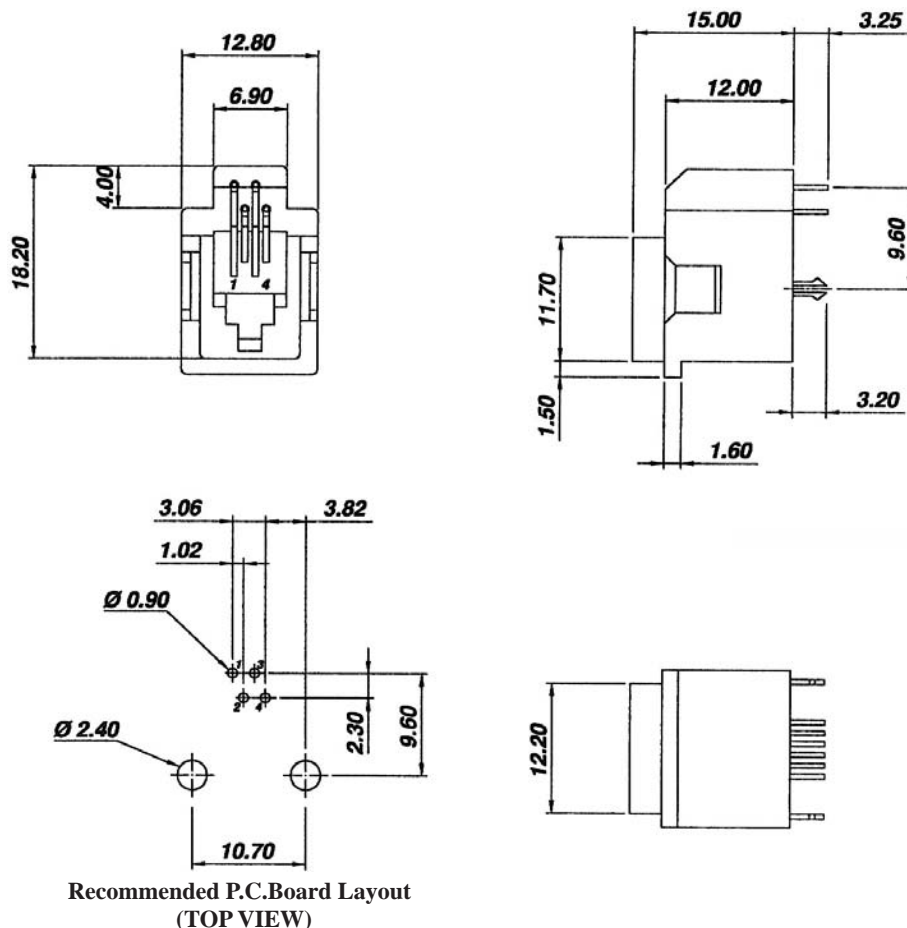
TOP ENTRY MODULAR PCB JACK 4P PROFILE=15.00MM (UNSHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
All materials must be RoHS compliant.



ORDERING INFORMATION:

P/N MJTK - 44 x B
 1 2

1. NO. OF POSITIONS & CONTACTS:

"44" 4P4C

2. CONTACT FINISH:

"A" 6 MICROINCH GOLD

"B" 15 MICROINCH GOLD

"C" 30 MICROINCH GOLD

"D" 50 MICROINCH GOLD

NOTE: P/N MJTKHT-44xB for High Temp. Version

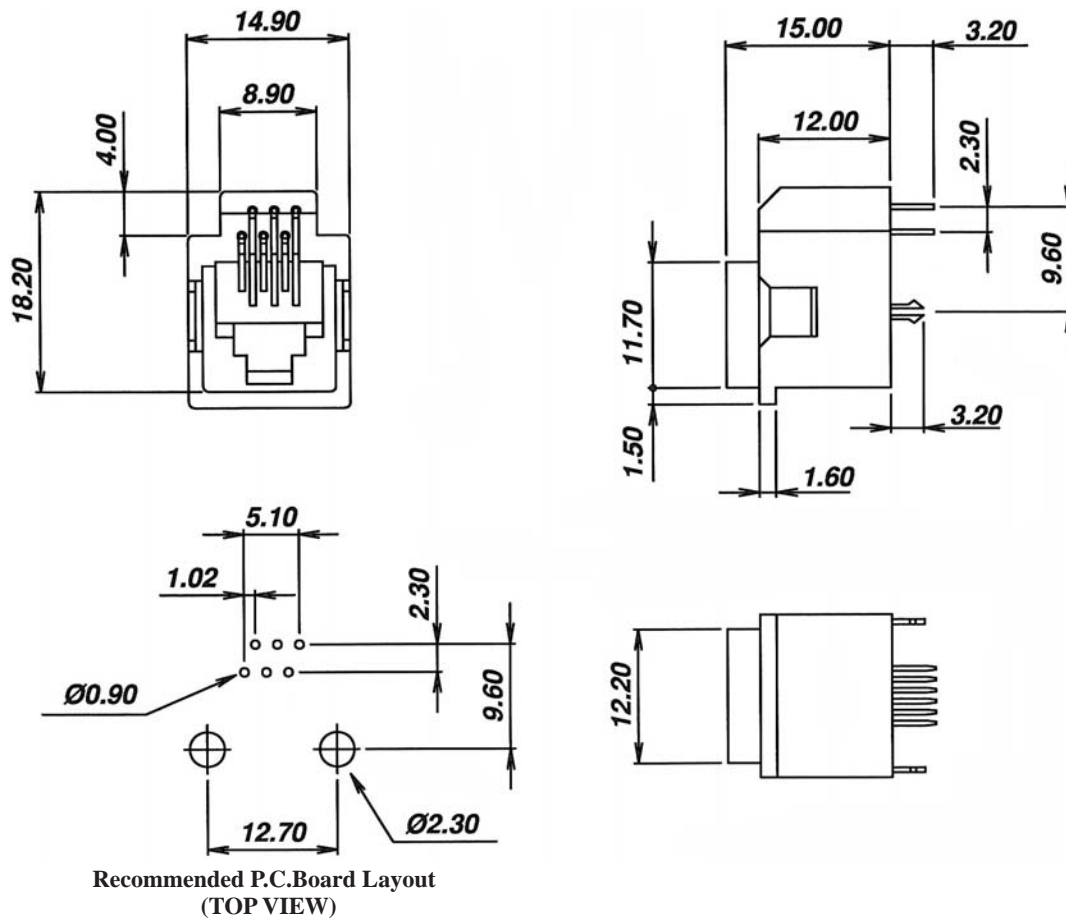
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ORDERING INFORMATION:

P/N M J T K - $\frac{x x x}{1 2}$ B

- NO. OF POSITIONS & CONTACTS:
 "66" 6P6C
 "64" 6P4C
- CONTACT FINISH:
 "A" 6 MICROINCH GOLD
 "B" 15 MICROINCH GOLD
 "C" 30 MICROINCH GOLD
 "D" 50 MICROINCH GOLD